阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任何异议请及时告之,我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。
- 4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

Read Statement

- 1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
- 2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
- 3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
- 4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets" .



S202SE2 Series

*Non-zero cross type is also available. (S202SE1 Series)

I_T(rms)≤8A, Reinforced Insulation Type Zero Cross type SIP 4pin Triac output SSR

■ Description

S202SE2 Series reinforced insulation type Solid State Relays (SSR) are an integration of an infrared emitting diode (IRED), a Phototriac Detector and a main output Triac. These devices are ideally suited for controlling high voltage AC loads with solid state reliability while providing 3.0kV isolation ($V_{iso}(rms)$) from input to output.

■ Features

- 1. Output current, I_T(rms)≤8.0A
- 2. Zero crossing functionary (V_{OX}: MAX. 35V)
- 3. 4 pin SIP package
- 4. High repetitive peak off-state voltage (V_{DRM}: 600V)
- 5. Reinforced insulation type (MIN. 0.4mm internal separation)
- 6. High isolation voltage between input and output $(V_{iso}(rms): 3.0kV)$
- 7. Lead-free terminal components are also available (see Model Line-up section in this datasheet)
- 8. Screw hole for heat sink

■ Agency approvals/Compliance

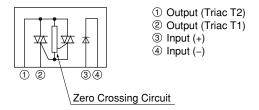
- 1. Recognized by UL508, file No. E94758 (as models No. S202SE2)
- Approved by CSA 22.2 No.14, file No. LR63705 (as models No. S202SE2)
- 3. Approved by TÜV EN60950 (reinforced insulation), file No. R9051479 (as models No. **S202SE2**)
- 4. Package resin: UL flammability grade (94V-0)

■ Applications

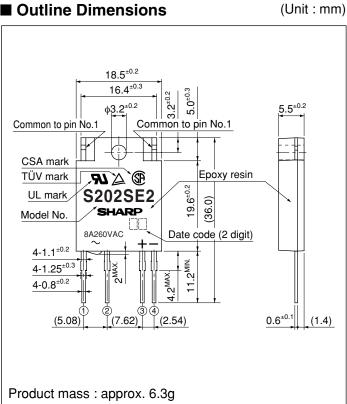
- 1. Isolated interface between high voltage AC devices and lower voltage DC control circuitry.
- 2. Switching motors, fans, heaters, solenoids, and valves.
- 3. Power control in applications such as lighting and temperature control equipment.



■ Internal Connection Diagram



■ Outline Dimensions



(): Typical dimensions



Date code (2 digit)

1st digit				2nd digit		
Year of production				Month of production		
A.D.	Mark	A.D	Mark	Month	Mark	
1990	A	2002	P	January	1	
1991	В	2003	R	February	2	
1992	С	2004	S	March	3	
1993	D	2005	T	April	4	
1994	Е	2006	U	May	5	
1995	F	2007	V	June	6	
1996	Н	2008	W	July	7	
1997	J	2009	X	August	8	
1998	K	2010	A	September	9	
1999	L	2011	В	October	0	
2000	M	2012	С	November	N	
2001	N	:	:	December	D	

repeats in a 20 year cycle

Country of origin Japan

Rank mark

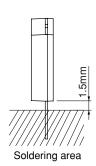
There is no rank mark indicator and currently there are no rank offered for this device.



■ Absolute Maximum Ratings

 $(T_a=25^{\circ}C)$

	_ _			-a -c -c)
	Parameter	Symbol	Rating	Unit
T4	Forward current	I_{F}	50 *3	mA
Input	Reverse voltage	V_R	6	V
	RMS ON-state current	I _T (rms)	8 *3	A
	Peak one cycle surge current	I _{surge}	80 *4	A
Output	Repetitive peak OFF-state voltage	VDRM	600	V
	Non-Repetitive peak OFF-state voltage	Vdsm	600	V
	Critical rate of rise of ON-state current	dI _T /dt	50	A/μs
	Operating frequency	f	45 to 65	Hz
*1Isolation voltage		V _{iso} (rms)	3.0	kV
Operating temperature		Topr	-25 to +100	°C
Storage temperature		T_{stg}	-30 to +125	°C
*2Soldering temperature		T_{sol}	260	°C



■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

Parameter		Symbol	Conditions		TYP.	MAX.	Unit
Input	Forward voltage	V_F	I _F =20mA	ı	1.2	1.4	V
	Reverse current	I_R	$V_R=3V$	1	1	100	μΑ
	Repentitive peak OFF-stage current	I_{DRM}	$V_D = V_{DRM}$	-	1	100	μΑ
	ON-state voltage	V _T (rms)	I _T (rms)=2A, Resistance load, I _F =20mA	ı	ı	1.5	V
Output	Holding current	I_{H}	_	ı	ı	50	mA
	Critical rate of rise of OFF-state voltage	dV/dt	$V_D=2/3 \bullet V_{DRM}$	30	-	_	V/µs
	Critical rate of rise of OFF-state voltage at commutaion	(dV/dt)c	$T_j=125$ °C, $V_D=2/3 \bullet V_{DRM}$, $dI_T/dt=-4.0A/ms$	5	1	_	V/µs
Transfer characteristics	Minimum trigger current	I_{FT}	$V_D=6V, R_L=30\Omega$	ı	ı	8	mA
	Zero cross voltage	V _{OX}	I _F =8mA	-	-	35	V
	Isolation resistance	R _{ISO}	DC500V, 40 to 60%RH	10^{10}	-	_	Ω
	Turn-on time	t _{on}	V _D (rms)=200V, AC60Hz	_	_	9.3	ms
	Turn-off time	t _{off}	$I_T(rms)=2A$, Resistance load, $I_F=20mA$	1	-	9.3	ms
Thermal resistance		R _{th} (j-c)	Between junction and case	ı	4.5	_	°C/W
		R _{th} (j-a)	Between junction and ambient	-	40	-	

^{*1 40} to 60%RH, AC for 1minute, f=60Hz *2 For 10s *3 Refer to Fig.1, Fig.2 *4 f=60Hz sine wave, T_j=25°C start



■ Model Line-up (1) (Lead-free terminal components)

Shipping Package	 ase es/case	V _{DRM}	$I_{FT}[mA]$ (V_D =6 V ,	
EN60950 (reinforced insulation)	 Approved	[V]	$R_L=30\Omega$)	
Model No.	 S202SE2F	600	MAX.8	

■ Model Line-up (2) (Lead solder plating components)

Shipping Package	Ca	ase	***	$I_{FT}[mA]$ $(V_D=6V,$	
Shipping Lackage	200pc	es/case	V _{DRM}		
EN60950 (reinforced insulation)		Approved	[V]	$R_L=30\Omega$)	
Model No.		S202SE2	600	MAX.8	

Please contact a local SHARP sales representative to see the actual status of the production.



Fig.1 Forward Current vs.
Ambient Temperature

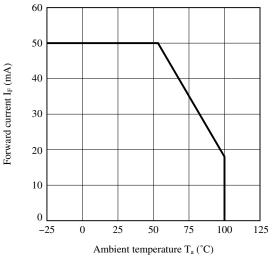


Fig.3 RMS ON-state Current vs. Case Temperature

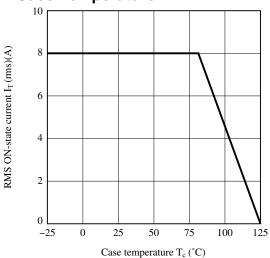


Fig.5 Surge Current vs. Power-on Cycle

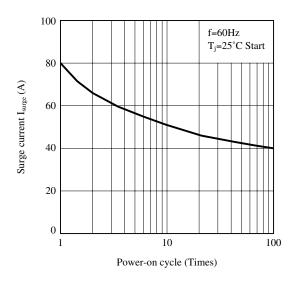


Fig.2 RMS ON-state Current vs. Ambient Temperature

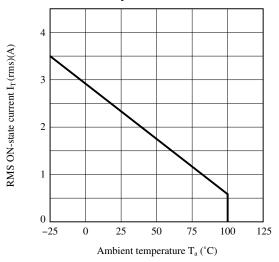


Fig.4 Forward Current vs. Forward Voltage

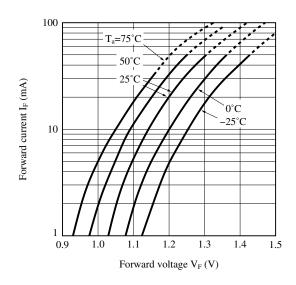
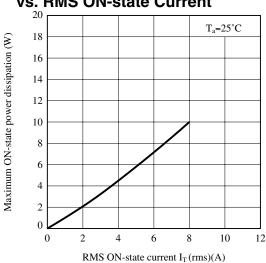


Fig.6 Maximum ON-state Power Dissipation vs. RMS ON-state Current



Sheet No.: D4-A03301EN



Fig.7 Minimum Trigger Current vs.
Ambient Temperature

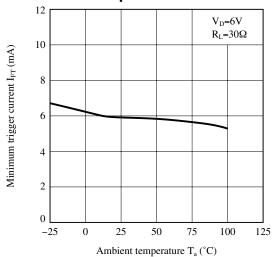
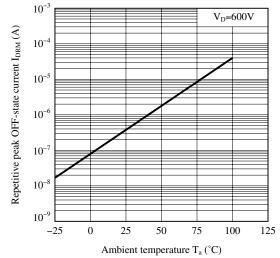


Fig.8 Repetitive Peak OFF-state Current vs. Ambient Temperature



Remarks: Please be aware that all data in the graph are just for reference.



■ Design Considerations

Recommended Operating Conditions

Parameter		Symbol	Conditions	MIN.	MAX.	Unit
Input	Input signal current at ON state	I _F (ON)	_	16	24	mA
	Input signal current at OFF state	I _F (OFF)	_	0	0.1	mA
Output	Load supply voltage	V _{OUT} (rms)	_	80	240	V
	Load supply current	I _{OUT} (rms)	Locate snubber circuit between output terminals (Cs=0.022 μ F, Rs=47 Ω)	0.1	I _T (rms) ×80%(*)	mA
	Frequency	f	_	47	63	Hz
Operating temperature		T_{opr}	-	-20	80	°C

^(*) See Fig.2 about derating curve (I_T(rms) vs. ambient temperature).

Design guide

In order for the SSR to turn off, the triggering current (I_F) must be 0.1mA or less.

When the input current (I_F) is below 0.1mA, the output Triac will be in the open circuit mode. However, if the voltage across the Triac, V_D , increases faster than rated dV/dt, the Triac may turn on. To avoid this situation, please incorporate a snubber circuit. Due to the many different types of load that can be driven, we can merely recommend some circuit vales to start with : $Cs=0.022\mu F$ and $Rs=47\Omega$. The operation of the SSR and snubber circuit should be tested and if unintentional switching occurs, please adjust the snubber circuit component values accordingly.

When making the transition from On to Off state, a snubber circuit should be used ensure that sudden drops in current are not accompanied by large instantaneous changes in voltage across the Triac.

This fast change in voltage is brought about by the phase difference between current and voltage.

Primarily, this is experienced in driving loads which are inductive such as motors and solenoids.

Following the procedure outlined above should provide sufficient results.

For over voltage protection, a Varistor may be used.

Any snubber or Varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

Particular attention needs to be paid when utilizing SSRs that incorporate zero crossing circuitry.

If the phase difference between the voltage and the current at the output pins is large enough, zero crossing type SSRs cannot be used. The result, if zero crossing SSRs are used under this condition, is that the SSR may not turn on and off irregardless of the input current. In this case, only a non zero cross type SSR should be used in combination with the above mentioned snubber circuit selection process.

The load current should be within the bounds of derating curve. (Refer to Fig.2) Also, please use the optional heat sink when necessary.

In case the optional heat sink is used and the isolation voltage between the device and the optional heat sink is needed, please locate the insulation sheet between the device and the heat sink.

When the optional heat sink is equipped, please set up the M3 screw-fastening torque at 0.3 to 0.5N• m. In order to dissipate the heat generated from the inside of device effectively, please follow the below suggestions.



- (a) Make sure there are no warps or bumps on the heat sink, insulation sheet and device surface.
- (b) Make sure there are no metal dusts or burrs attached onto the heat sink, insulation sheet and device surface.
- (c) Make sure silicone grease is evenly spread out on the heat sink, insulation sheet and device surface.

Silicone grease to be used is as follows;

- 1) There is no aged deterioration within the operating temperature ranges.
- 2) Base oil of grease is hardly separated and is hardly permeated in the device.
- 3) Even if base oil is separated and permeated in the device, it should not degrade the function of a device.

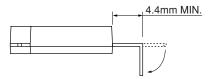
Recommended grease: G-746 (Shin-Etsu Chemical Co., Ltd.)

: G-747 (Shin-Etsu Chemical Co., Ltd.)

: SC102 (Dow Corning Toray Silicone Co., Ltd.)

In case the optional heat sink is screwed up, please solder after screwed.

In case of the lead frame bending, please keep the following minimum distance and avoid any mechanical stress between the base of terminals and the molding resin.

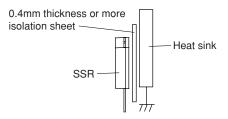


Some of AC electromagnetic counters or solenoids have built-in rectifier such as the diode.

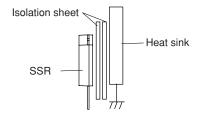
In this case, please use the device carefully since the load current waveform becomes similar with rectangular waveform and this results may not make a device turn off.

Example how to equip optional heat sink for reinforced isolation

1) Case of isolation sheet whose thickness is 0.4mm or more (V_{iso}: 3kV or more)



2) Case of the use of double isolation sheet (Viso: each 3kV or more)



Please keep 5mm distance as minimum between naked metal portion of SSR and heat sink, and also between naked metal portion of SSR and bis/nut/washer.

However, please avoid the natural rubber for isolation sheet.



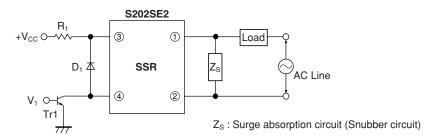
Degradation

In general, the emission of the IRED used in SSR will degrade over time.

In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

Therefore in order to maintain proper operation, a design implementing these SSRs should provide at least twice the minimum required triggering current from initial operation.

Standard Circuit



[☆] For additional design assistance, please review our corresponding Optoelectronic Application Notes.



■ Manufacturing Guidelines

Soldering Method

Flow Soldering (No solder bathing)

Flow soldering should be completed below 260°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please solder within one time.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

Sheet No.: D4-A03301EN



■ Package specification

Package materials

Packing case: Corrugated cardboard
Partition: Corrugated cardboard
Pad: Corrugated cardboard
Cushioning material: Polyethylene

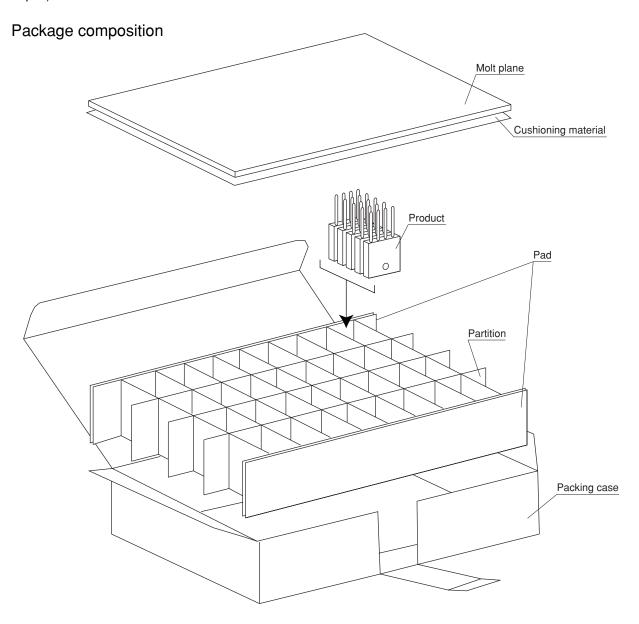
Molt plane: Urethane

Package method

The product should be located after the packing case is partitioned and protected inside by 4 pads.

Each partition should have 5 products with the lead upward.

Cushioning material and molt plane should be located after all products are settled (1 packing contains 200 pcs).





■ Important Notices

- · The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- · Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- · Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
- (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - --- Personal computers
 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
- (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
 - --- Space applications
 - --- Telecommunication equipment [trunk lines]
 - --- Nuclear power control equipment
 - --- Medical and other life support equipment (e.g., scuba).
- · If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- · This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.